# MOSFET – Power, Single **N-Channel 40 V. 1.4 mΩ. 200 A**

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS5C430NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

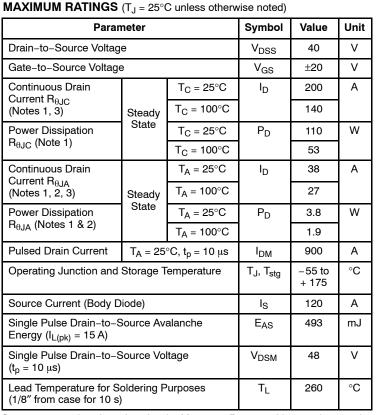


# **ON Semiconductor®**

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V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
40 V	1.4 mΩ @ 10 V	200 A
40 V	$2.2 \text{ m}\Omega @ 4.5 \text{ V}$	200 A

D (5,6) Q



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

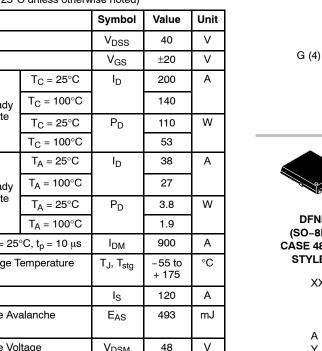
#### THERMAL RESISTANCE MAXIMUM RATINGS

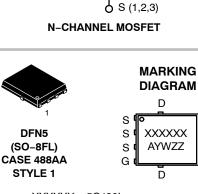
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.4	°C/W
Junction-to-Ambient - Steady State (Note 2)	R <sub>θJA</sub>	40	

The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

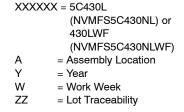
Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.





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#### **ORDERING INFORMATION**

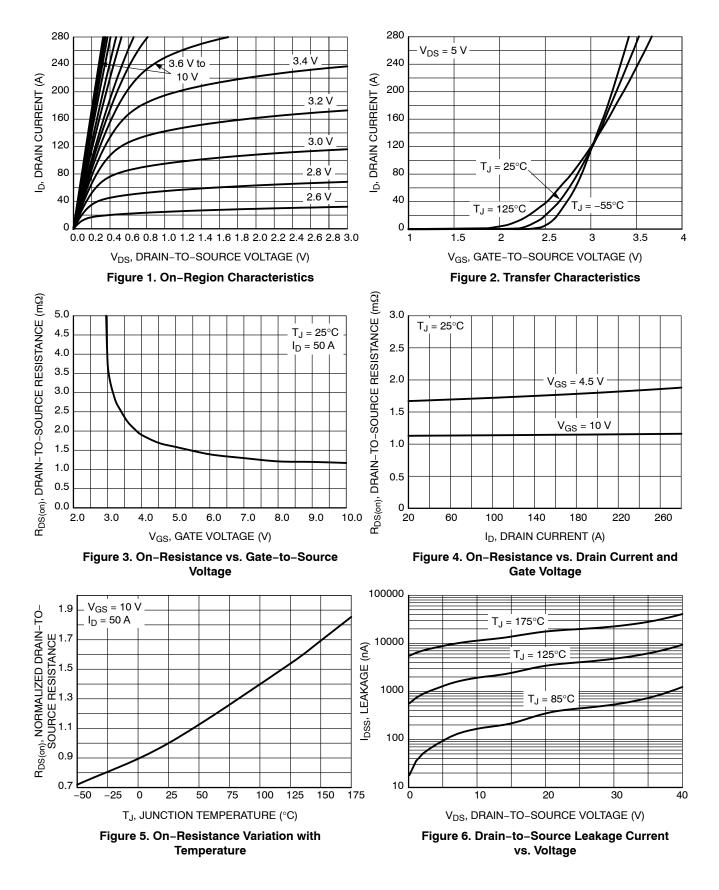
See detailed ordering, marking and shipping information on page 5 of this data sheet.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise specified)

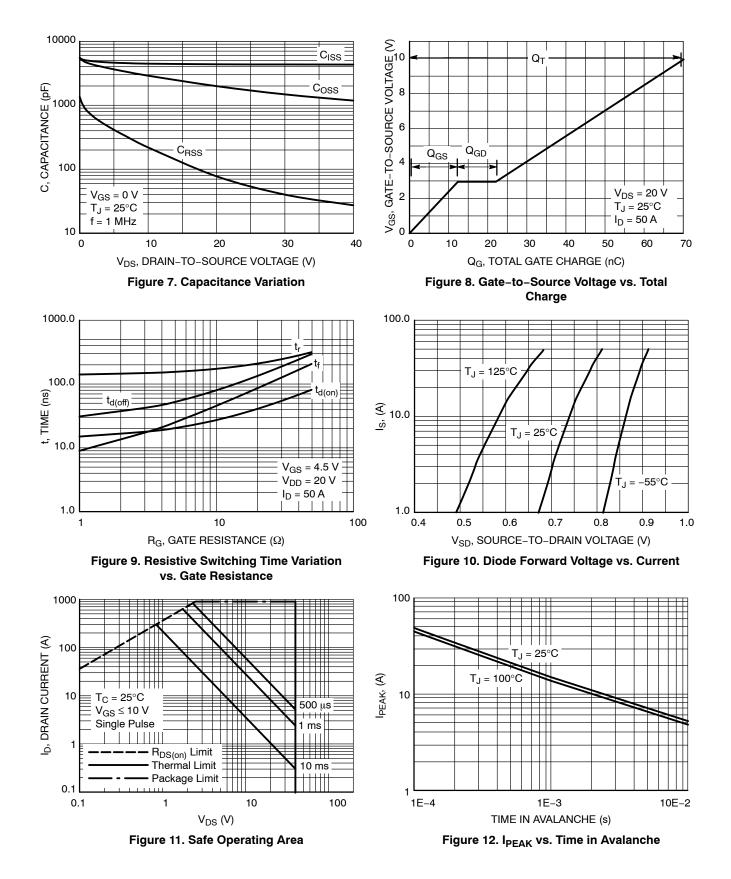
Parameter	Symbol	Test Conc	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	-					-	
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D$	= 250 μA	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				1.3		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 40 V	T <sub>J</sub> = 25 °C			10	μΑ
			T <sub>J</sub> = 125°C			250	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)	-					-	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-5.6		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 50 A		1.7	2.2	_
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 50 A		1.2	1.4	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> =15 V, I <sub>D</sub> = 50 A			180		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 20 V			4300		
Output Capacitance	C <sub>OSS</sub>				1900		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				72		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS} = 4.5 \text{ V}, V_{DS} = 20 \text{ V}; \text{ I}_{D} = 50 \text{ A}$ $V_{GS} = 10 \text{ V}, V_{DS} = 20 \text{ V}; \text{ I}_{D} = 50 \text{ A}$			32		
Total Gate Charge	Q <sub>G(TOT)</sub>				70		
Threshold Gate Charge	Q <sub>G(TH)</sub>				7.0		nC
Gate-to-Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 20 V; I <sub>D</sub> = 50 A			12		
Gate-to-Drain Charge	Q <sub>GD</sub>				9.0		
Plateau Voltage	V <sub>GP</sub>				2.9		V
SWITCHING CHARACTERISTICS (Note 5	5)					-	
Turn-On Delay Time	t <sub>d(ON)</sub>				15		
Rise Time	tr	V <sub>GS</sub> = 4.5 V. V			140		
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$\begin{array}{c} V_{GS}=\text{4.5 V, } V_{DS}=\text{20 V,} \\ I_{D}=\text{50 A, } R_{G}=\text{1 } \Omega \end{array}$			31		- ns
Fall Time	t <sub>f</sub>				9		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V,$ $I_{S} = 50 A$	$T_J = 25^{\circ}C$		0.81	1.2	
			T <sub>J</sub> = 125°C		0.68		V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dl <sub>s</sub> /dt = 100 A/µs, I <sub>S</sub> = 50 A			61		ns
Charge Time	t <sub>a</sub>				29		
Discharge Time	t <sub>b</sub>				32		
Reverse Recovery Charge	Q <sub>RR</sub>				80		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

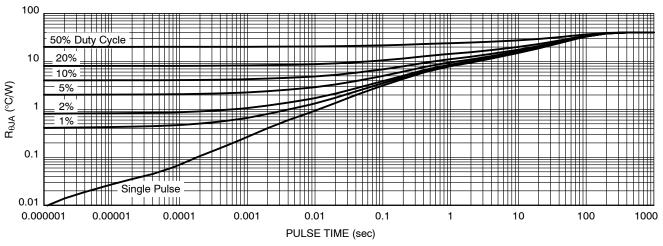
#### **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**



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**Figure 13. Thermal Characteristics** 

Device	Marking	Package	Shipping <sup>†</sup>
NVMFS5C430NLT1G	5C430L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C430NLWFT1G	430LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C430NLT3G	5C430L	DFN5 (Pb-Free)	5000 / Tape & Reel
NVMFS5C430NLWFT3G	430LWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C430NLAFT1G	5C430L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C430NLWFAFT1G	430LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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